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01/09/2002

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U.S. UTILITY Patent Application

PATENT NUMBER and  
ISSUE DATE

APPLICATION		FILING DATE		CLASS		SUBCLASS		GAU		EXAMINER	
APPL NUM	10040378	FILING DATE	01/09/2002	CLASS	246	SUBCLASS		GAU	1746	EXAMINER	Vinh
<b>**APPLICANTS:</b> Komada Daisuke;											
<b>**CONTINUING DATA VERIFIED:</b>											
<b>** FOREIGN APPLICATIONS VERIFIED:</b> verified LV JAPAN 2001-300562 09/28/2001											
PG-PUB		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>							
Foreign priority claimed		<input checked="" type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO							
35 USC 119 conditions met		<input checked="" type="checkbox"/> yes <input type="checkbox"/> no		107317-00040							
Verified and Acknowledged Examiners's initials											
TITLE : Manufacture method for semiconductor device having silicon-containing insulating film											

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	
ISSUE FEE		Total Claims	
Amount Due	Date Paid	Print Claim for O.G.	
		DRAWING	
		Sheets Drwg. Figs.Drwg. Print Fig.	
		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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